

Vishay Siliconix

P-Channel 1.8-V (G-S) MOSFET

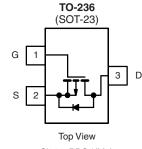
PRODUCT SUMMARY				
V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A)		
	0.050 at V _{GS} = - 4.5 V	- 3.85		
- 12	0.065 at V _{GS} = - 2.5 V	- 3.4		
	0.100 at V _{GS} = - 1.8V	- 2.7		

FEATURES

- Halogen-free Option Available
- TrenchFET[®] Power MOSFETs: 1.8 V Rated



RoHS*



Si2315BDS *(M5) * Marking Code

Ordering Information: Si2315BDS-T1 Si2315BDS-T1-E3 (Lead (Pb)-free) Si2315BDS-T1-GE3 (Lead (Pb)-free and Halogen-free)

ABSOLUTE MAXIMUM RATINGS	T _A = 25 °C, unle	ss otherwise r	noted		
Parameter		Symbol	5 s	Steady State	Unit
Drain-Source Voltage		V _{DS}	- 12		V
Gate-Source Voltage		V _{GS}	± 8		v
Continuous Drain Ourrent (T. 150 %0)d	T _A = 25 °C	- I _D	- 3.85	- 3.0	
Continuous Drain Current $(T_J = 150 \ ^{\circ}C)^a$	T _A = 70 °C		- 3.0	- 2.45	
Pulsed Drain Current ^a		I _{DM}	- 12		A
Continuous Source Current (Diode Conduction) ^a		۱ _S	- 1.0	- 0.62	
	T _A = 25 °C	L 1.19 0.75		0.75	W
Power Dissipation ^a	T _A = 70 °C	- P _D	0.76	0.48	vv
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55	to 150	°C

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Тур.	Max.	Unit
Maximum lumation to Ambienta	t ≤ 5 s	R _{thJA}	85	105	°C/W
Maximum Junction-to-Ambient ^a	Steady State	' 'thJA	130	166	
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	60	75	

Notes:

a. Surface Mounted on FR4 board.

For SPICE model information via the Worldwide Web: http://www.vishay.com/www/product/spice.htm.

* Pb containing terminations are not RoHS compliant, exemptions may apply.

b. $t \le 5$ s.

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SPECIFICATIONS $T_J = 25$	°C, unless o	therwise noted					
					Limits		
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 V, I_{D} = -10 \mu A$	- 12			v	
Gate-Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = -250 \ \mu A$	- 0.45		- 0.90		
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 8 V$			± 100	nA	
	1	$V_{DS} = -12 V, V_{GS} = 0 V$			- 1		
Zero Gate Voltage Drain Current	IDSS	V_{DS} = - 12 V, V_{GS} = 0 V, T_{J} = 55 °C			- 10	μA	
0		$V_{DS} \leq$ - 5 V, V_{GS} = - 4.5 V	- 6			A	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \leq$ - 5 V, V_{GS} = - 2.5 V	- 3				
		V_{GS} = - 4.5 V, I _D = - 3.85 A		0.040	0 0.050		
Drain-Source On Resistance ^a	R _{DS(on)}	$V_{GS} = -2.5 \text{ V}, \text{ I}_{D} = -3.4 \text{ A}$		0.050	0.065	Ω	
		V_{GS} = - 1.8 V, I _D = - 2.7 A		0.071	0.100		
Forward Transconductance ^a	9 _{fs}	$V_{DS} = -5 V$, $I_{D} = -3.85 A$		7		S	
Diode Forward Voltage ^a	V _{SD}	I _S = - 1.6 A, V _{GS} = 0 V			- 1.2	V	
Dynamic ^b	· · · ·						
Total Gate Charge	Qg	N 0.11 15 1		8	15		
Gate-Source Charge	Q _{gs}	V _{DS} = - 6 V, V _{GS} = - 4.5 V I _D ≅ - 3.85 A		1.1		nC	
Gate-Drain Charge	Q _{gd}	ID= - 0.00 A		2.3		1	
Input Capacitance	C _{iss}			715			
Output Capacitance	C _{oss}	V_{DS} = - 6 V, V_{GS} = 0 V, f = 1 MHz		275		pF	
Reverse Transfer Capacitance	C _{rss}			200		1	
Switching ^b				•			
Turn-On Time	t _{d(on)}			15	20		
	t _r	$V_{DD} = -6 \text{ V}, \text{ R}_{L} = 6 \Omega$ $I_{D} \cong -1.0 \text{ A}, \text{ V}_{GEN} = -4.5 \text{ V}$		35	50	n c	
Turn-Off Time	t _{d(off)}	$R_{G} = 6 \Omega$		50	70	ns	
	t _f			50	75		

Notes:

a. For DESIGN AID ONLY, not subject to production testing.

b. Pulse test: PW \leq 300 µs duty cycle \leq 2 %.

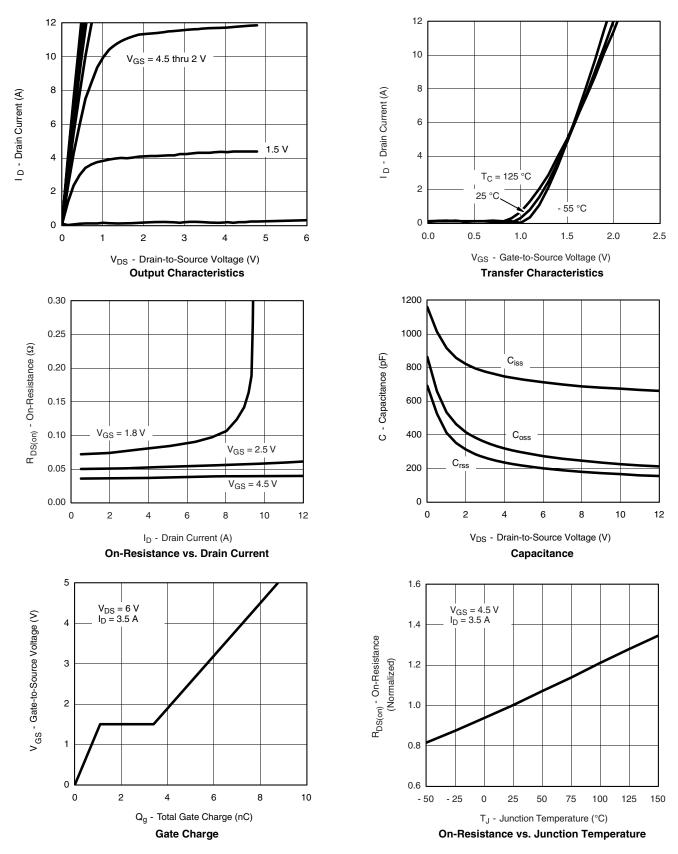
c. Switching time is essentially independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



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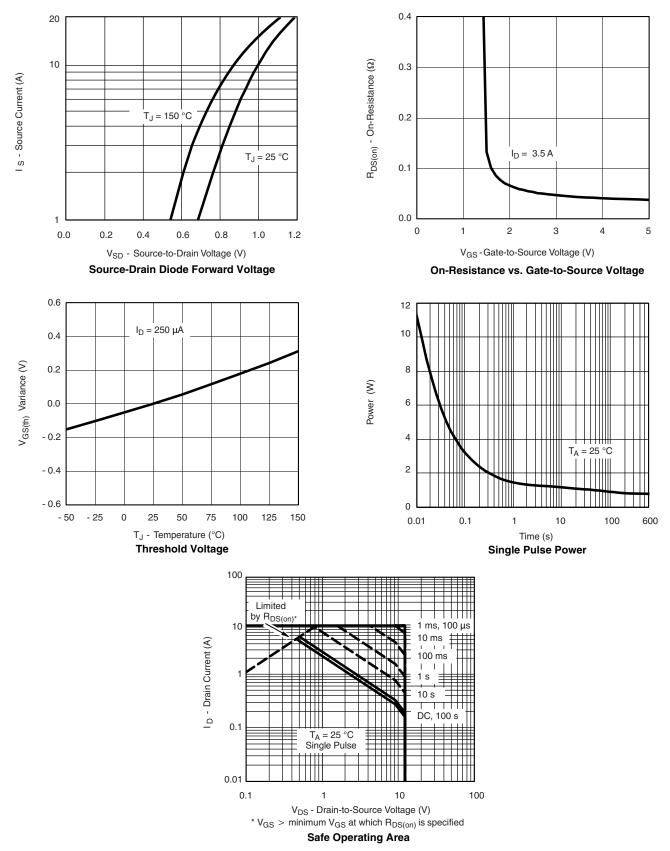
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

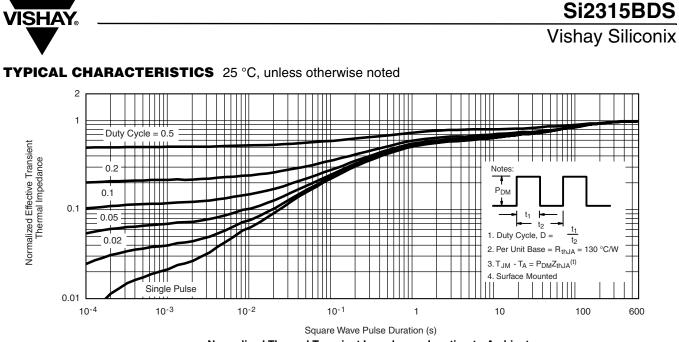


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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





Normalized Thermal Transient Impedance, Junction-to-Ambient

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?72014.



Package Information

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SOT-23 (TO-236): 3-LEAD







Dim	MILLIN	METERS	INCHES		
	Min	Max	Min	Мах	
Α	0.89	1.12	0.035	0.044	
A ₁	0.01	0.10	0.0004	0.004	
A ₂	0.88	1.02	0.0346	0.040	
b	0.35	0.50	0.014	0.020	
С	0.085	0.18	0.003	0.007	
D	2.80	3.04	0.110	0.120	
E	2.10	2.64	0.083	0.104	
E ₁	1.20	1.40	0.047	0.055	
е	0.95 BSC		0.0374 Ref		
e ₁	1.90 BSC		0.0748 Ref		
L	0.40	0.60	0.016	0.024	
L ₁	0.64 Ref		0.025 Ref		
S	0.50 Ref		0.020 Ref		
q	3°	8°	3°	8°	



Application Note 826

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RECOMMENDED MINIMUM PADS FOR SOT-23



Recommended Minimum Pads Dimensions in Inches/(mm)

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